



**CHENMKO ENTERPRISE CO.,LTD**

*Lead free devices*

**SURFACE MOUNT  
PNP Switching Transistor**

**VOLTAGE 40 Volts CURRENT 0.2 Ampere**

**CH3906WPT**

**APPLICATION**

- \* Telephony and professional communication equipment.
- \* Other switching applications.

**FEATURE**

- \* Small surface mounting type. (SC-70/SOT-323)
- \* Low current (Max.=200mA).
- \* Suitable for high packing density.
- \* Low voltage (Max.=40V).
- \* High saturation current capability.
- \* Voltage controlled small signal switch.

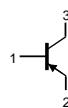
**CONSTRUCTION**

- \* PNP Switching Transistor

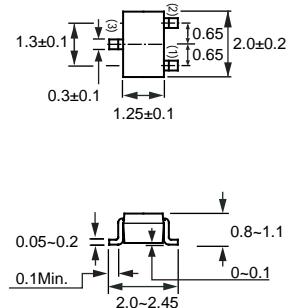
**MARKING**

- \* PC

**CIRCUIT**



**SC-70/SOT-323**



Dimensions in millimeters

**SC-70/SOT-323**

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	—	-40	V
$V_{CEO}$	collector-emitter voltage	open base	—	-40	V
$V_{EBO}$	emitter-base voltage	open collector	—	-5	V
$I_C$	collector current DC		—	-200	mA
$I_{CM}$	peak collector current		—	-200	mA
$I_{BM}$	peak base current		—	-100	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$ ; note 1	—	200	mW
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature		—	150	°C
$T_{amb}$	operating ambient temperature		-65	+150	°C

**Note**

1. Transistor mounted on an FR4 printed-circuit board.

## RATING CHARACTERISTIC CURVES ( CH3906WPT )

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	500	K/W

**Note**

- Transistor mounted on an FR4 printed-circuit board.

### CHARACTERISTICS

$T_{amb} = 25^\circ C$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_{CBO}$	collector cut-off current	$I_E = 0; V_{CB} = -30 V$	—	-50	nA
$I_{EBO}$	emitter cut-off current	$I_C = 0; V_{EB} = 6 V$	—	-50	nA
$h_{FE}$	DC current gain	$V_{CE} = -1 V$ ; note 1 $I_C = -0.1 mA$ $I_C = -1 mA$ $I_C = -10 mA$ $I_C = -50 mA$ $I_C = -100 mA$	60 80 100 60 30	— — 300 — —	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -10 mA; I_B = -1 mA$ $I_C = -50 mA; I_B = -5 mA$	— —	-250 -400	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -10 mA; I_B = -1 mA$ $I_C = -50 mA; I_B = -5 mA$	-650 —	-850 -950	mV
$C_c$	collector capacitance	$I_E = i_e = 0; V_{CB} = -5 V; f = 1 MHz$	—	4.5	pF
$C_e$	emitter capacitance	$I_C = i_e = 0; V_{EB} = -500 mV; f = 1 MHz$	—	10	pF
$f_T$	transition frequency	$I_C = 10 mA; V_{CE} = -20 V; f = 100 MHz$	250	—	MHz
$F$	noise figure	$I_C = 100 \mu A; V_{CE} = -5 V; R_S = 1 k\Omega; f = 10 Hz to 15.7 kHz$	—	4	dB

### Switching times (between 10% and 90% levels);

$t_{on}$	turn-on time	$I_{Con} = -10 mA; I_{Bon} = -1 mA; I_{Boff} = 1 mA$	—	65	ns
$t_d$	delay time		—	35	ns
$t_r$	rise time		—	35	ns
$t_{off}$	turn-off time		—	300	ns
$t_s$	storage time		—	225	ns
$t_f$	fall time		—	75	ns

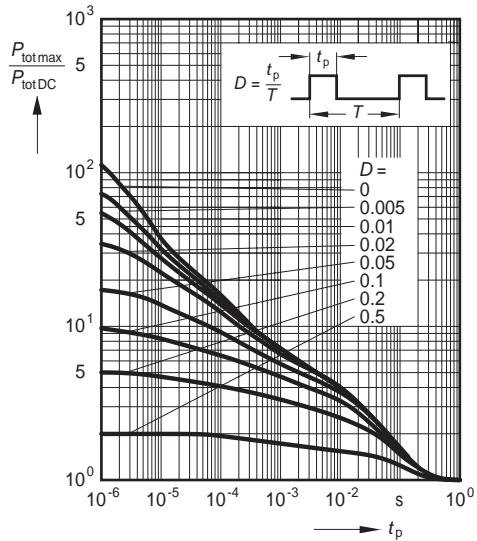
**Note**

- Pulse test:  $t_p \leq 300 \mu s; \delta \leq 0.02$ .

## RATING CHARACTERISTIC CURVES ( CH3906WPT )

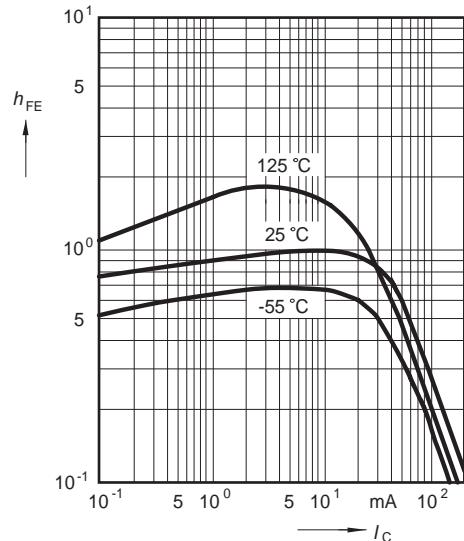
### Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$



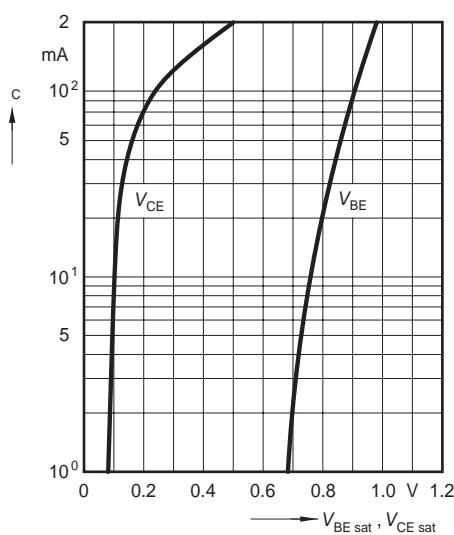
### DC current gain $h_{\text{FE}} = f(I_C)$

$$V_{\text{CE}} = 1 \text{ V, normalized}$$



### Saturation voltage $I_C = f(V_{\text{BEsat}}, V_{\text{CESat}})$

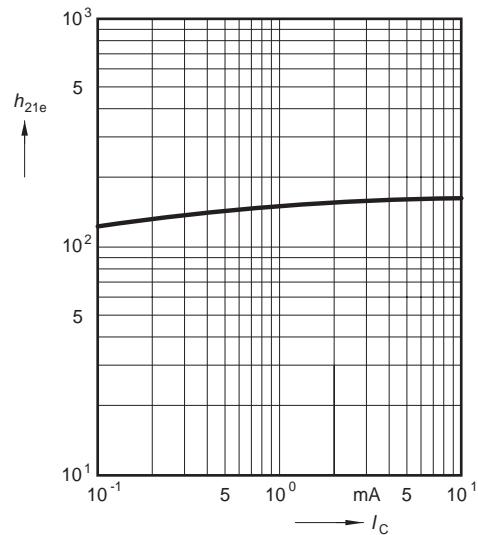
$$h_{\text{FE}} = 10$$



### Short-circuit forward current

$$\text{transfer ratio } h_{21e} = f(I_C)$$

$$V_{\text{CE}} = 10 \text{ V, } f = 1 \text{ MHz}$$

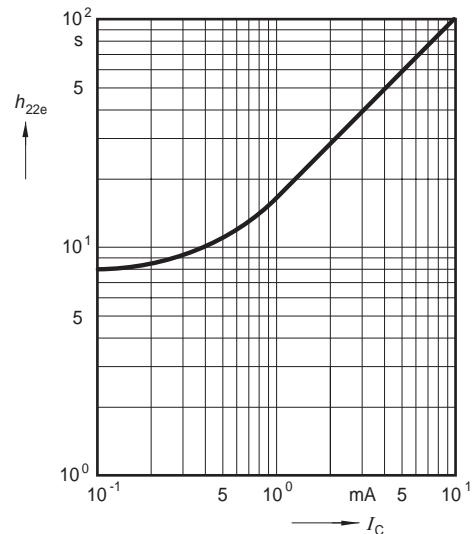


## RATING CHARACTERISTIC CURVES ( CH3906WPT )

**Open-circuit output admittance**

$$h_{22e} = f(I_C)$$

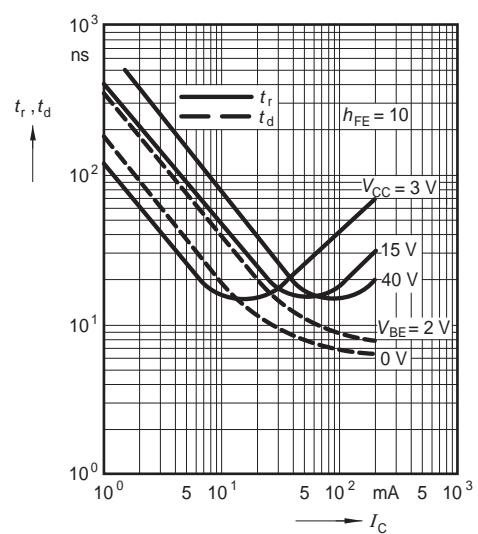
$V_{CE} = 10V, f = 1MHz$



**Fall time  $t_f = f(I_C)$**

**Delay time  $t_d = f(I_C)$**

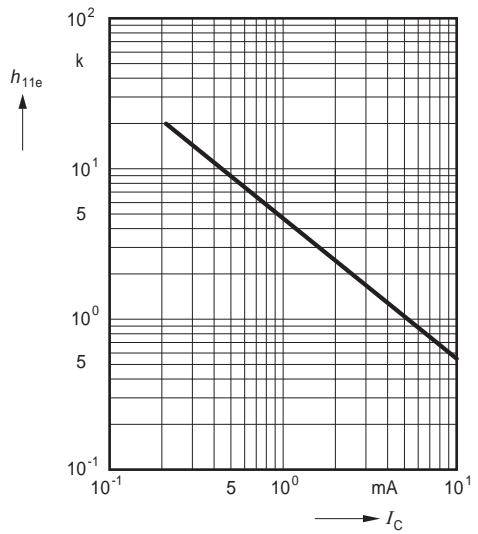
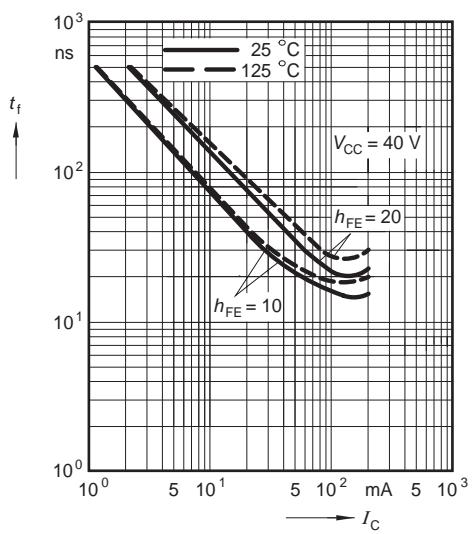
**Rise time  $t_r = f(I_C)$**



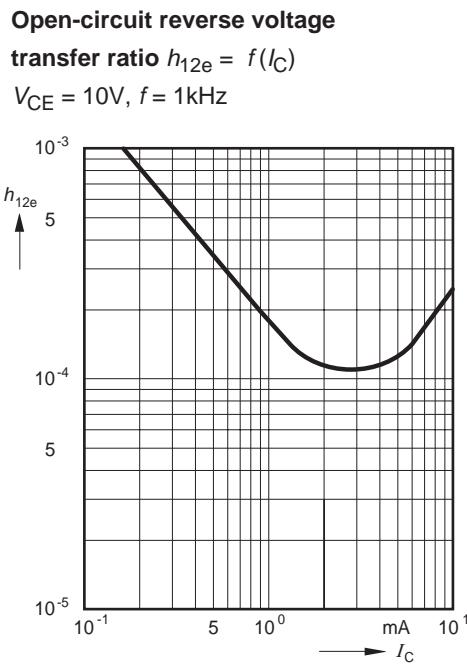
**Input impedance**

$$h_{11e} = f(I_C)$$

$V_{CE} = 10 V, f = 1kHz$



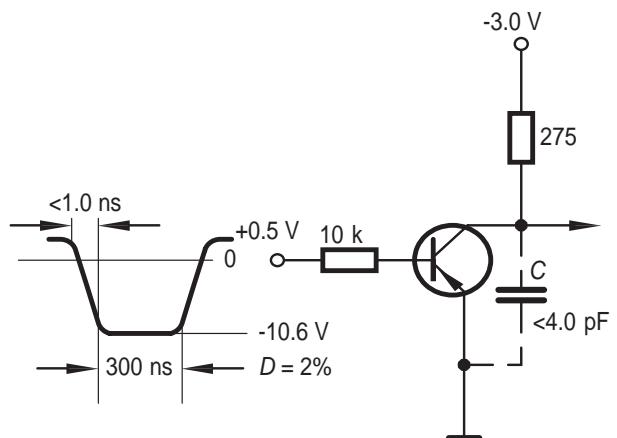
## RATING CHARACTERISTIC CURVES ( CH3906WPT )



## RATING CHARACTERISTIC CURVES ( CH3906WPT )

## Test circuit

## Delay and rise time



## Storage and fall time

